

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("Ti.sub.o2") with (solder adj (bump or ball))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:15
L2	1	("Ti.sub.o2")	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:15
L3	0	("Ti.sub.o.sub.2") and (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:17
L4	9	("Ti.sub.o.sub.2")	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:17
L5	162	(titanium adj oxide) and (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:17
L6	0	(titanium adj oxide) with (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:17
L7	13	(oxidation adj layer) with (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:27
L8	3	(oxidation adj film) with (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:28
L9	0	(titanium adj oxide) with (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:40
L10	13	(oxidized adj layer) with (solder adj (ball or bump))	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:50
L11	37	(oxidized adj layer) with via	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:55
L12	14	((oxidiz\$5 adj layer) with barrier) and solder	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 12:14
L13	1	("6271469").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/09 12:14
S1	1	"20050230794".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 13:56
S2	1864	(257/735,693).CCLS.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 16:53

S3	415	257/735,693.ccls. and solder and semiconductor and pad	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:02
S4	1	("6873040").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:02
S5	10	("5523586" "5578869" "5608262" "5724230" "5790384" "5798567" "5889323" "5901050" "6084308" "6188578").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 14:03
S6	1	("6268648").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:04
S7	1	("6271469").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:07
S8	1	("6455920").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:11
S9	1	"2002231854".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:12
S10	0	"200208556".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:12
S11	1	"2002008556".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:13
S12	1	"2000208556".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:13
S13	1	"20020192867".pn.	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 14:26
S14	1	("6271588").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:26
S15	1	("5672912").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 14:43
S16	1	("6300685").PN.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/11/08 14:43
S17	8	("5394009" "5627408" "5777391" "5793104" "5864174" "5956233" "5976916" "6013948").PN..	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 14:45

S18	10	("5523586" "5578869" "5608262" "5724230" "5790384" "5798567" "5889323" "5901050" "6084308" "6188578").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 14:49
S19	5	("20020158345" "20020191406" "6338893" "6372158" "6501169").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 15:00
S20	9	("20020149113" "20030030133" "4756467" "5148266" "5719070" "5937320" "6013572" "6310403" "6486411").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 15:04
S21	8	("5541450" "5592025" "5831832" "5841191" "5859475" "5990547" "6278613" "6331451").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 15:09
S22	9	("4151543" "4922322" "5164566" "5705858" "5892288" "6013953" "6130112" "6169328" "6265782").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 15:15
S23	0	257/735,693.ccls. and (solder with barrier with post)	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 16:53
S24	49	(solder with barrier with post)	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 17:07
S25	5	("6534387").URPN.	USPAT	AND	OFF	2005/11/08 17:03
S26	3	("5391916" "6281026" "6291309").PN.	US-PGPUB; USPAT; USOCR	AND	OFF	2005/11/08 17:05
S27	0	(solder with barrier with oxid\$8 with post)	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/08 17:08
S28	52	(solder with oxid\$8 with post)	US-PGPUB; USPAT; EPO; JPO	AND	OFF	2005/11/09 11:03